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Performance evaluation of high-detectivity p-i-n infrared photodetector based on compressively-strained $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ multiple quantum wells by quantum modelling

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Abstract

GeSn/Ge p-i-n photodetectors with practical $\text{Ge}_{0.964}\text{Sn}_{0.036}$ active layers are theoretically investigated. First, we calculated the electronic band parameters for the heterointerfaces between strained $\text{Ge}_{1-x}\text{Sn}_x$ and relaxed (001)-oriented Ge. The carrier transport in a p-i-n photodiode built on a ten-period $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ multiple quantum well absorber was then analyzed and numerically simulated within the Tsu–Esaki formalism by self-consistently solving the Schrödinger and Poisson equations, coupled to the kinetic rate equations. Photodetection up to a $2.1\ \mu\text{m}$ cut-off wavelength is achieved. High responsivities of $0.62\ \text{A W}^{-1}$ and $0.71\ \text{A W}^{-1}$ were obtained under a reverse bias voltage of $-3\ \text{V}$ at peak wavelengths of $1550\ \text{nm}$ and $1781\ \text{nm}$, respectively. Even for this low Sn-fraction, it is found that the photodetector quantum efficiency ($49\% @ 1.55\ \mu\text{m}$) is higher than those of comparable pure-Ge devices at room temperature. Detectivity of $3.8 \times 10^{10}\ \text{cm Hz}^{1/2}\ \text{W}^{-1}$ and $7.9 \times 10^{10}\ \text{cm Hz}^{1/2}\ \text{W}^{-1}$ at $-1\ \text{V}$ and $-0.5\ \text{V}$, respectively, is achievable at room temperature for a $1550\ \text{nm}$ wavelength peak of responsivity. This work represents a step forward in developing GeSn/Ge based infrared photodetectors.

Keywords: infrared photodetectors, detectivity, band structure engineering

1. Introduction

In recent years, there has been increasing effort toward the development and realisation of group IV semiconductor optoelectronic devices, recently encouraged by their possible heterogeneous integration with CMOS technology on silicon

on insulator (SOI) and germanium on insulator (GeOI) substrates. The progress made on key photonics components, including laser sources, optical modulators and photodetectors, has been demonstrated in detail [1]. Due to its relatively high absorption coefficient at $1.3\text{--}1.55\ \mu\text{m}$, Ge is regarded as the best candidate material for detection in this spectral range. However, the optical response of thin vertical Ge-based high frequency photodetectors at the telecommunication wavelength of $1.55\ \mu\text{m}$ is limited [2]. An

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Table 1. Summary of the lattice constants (in angstrom), elastic stiffness constants (in 10^{11} dyn cm $^{-2}$), conduction and valence band deformation potentials, spin-orbit splitting and bulk bandgaps (in eV) of Ge and α -Sn. All symbols are used in their conventional meanings (see [19–21]).

	a	c_{11}	c_{12}	$a_c(\Gamma)$	$a_c(L)$	$E_{v,av}$	b	Δ_0	$E_g(\Gamma)$	$E_g(L)$
Ge	5.6579	12.85	4.83	-8.24	-1.54	0	-2.9	0.30	0.798	0.664
α -Sn	6.4892	6.9	2.93	-6	-2.14	0.69	-2.7	0.80	-0.413	0.092

increase of the responsivity for these wavelengths can be achieved by intermixing Sn to Ge [3]. Thus, $\text{Ge}_{1-x}\text{Sn}_x$ alloy is an interesting alternative since its bandgap, which is smaller than that of Ge, may further improve the optical response at $1.55\ \mu\text{m}$ and will push the spectral range to longer infrared wavelengths [4–6]. On the other hand, GeSn alloy has poor thermal stability [7, 8], which prevents its application in optoelectronic devices. In addition, the large lattice mismatch with Ge ($\sim 15\%$) and the extremely low ($x < 1\%$) solid solubility of Sn in Ge makes it very difficult to grow high-quality defect-free GeSn [9]. Notwithstanding, GeSn alloys with a few per cent Sn content can only be grown under non-equilibrium conditions. Despite these difficulties, some effort has been made toward the epitaxial growth of GeSn alloys [7, 8, 10] and the fabrication of GeSn based devices [4]. Recently, there have been reports on GeSn p-i-n photodetectors with small Sn content for full telecommunication spectral range applications [11]. These results show that adding Sn in a p-i-n Ge photodiode matrix also increases the responsivity of the detector in the telecom wavelength range and extends the cut-off wavelength beyond $1.7\ \mu\text{m}$ [12–14]. Su *et al* published the first GeSn p-i-n photodetector grown by solid-source molecular beam epitaxy with 3% Sn composition and 820 nm thick layers [14]. At 1640 nm, they measured strong reverse voltage dependence with a small optical responsivity of $50\ \text{mA W}^{-1}$ under zero bias operation. Strangely, the Sn incorporation shifts the detector cut-off responsivity towards the infrared spectral range by 60 nm only. The detection wavelength of GeSn p-i-n photodetectors fabricated on Ge substrate with Sn contents up to 3.6% in the active layer has recently reached $1.95\ \mu\text{m}$ [15]. Photodiodes built on lattice relaxed $\text{Ge}_{1-x}\text{Sn}_x$ layers [15, 16] may exhibit large densities of defects, such as dislocations acting as recombination traps, resulting in an excessive dark current. Strained $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ multiple quantum wells (MQWs) may be used as an absorbing layer to adjust the absorption threshold and to reduce the dark current. However, owing to the serial resistance induced by the number of quantum barriers, a limited number of cells or coupled quantum wells in the superlattice regime should be used. In order to design such a device, we first determine the electronic properties of strained $\text{Ge}_{1-x}\text{Sn}_x$ on (001)-oriented Ge, such as bandgap energy and band discontinuities. Then, we propose a p-i-n infrared photodetector with an intrinsic absorbing layer formed by strain-compensated $\text{Ge}/\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ multi-quantum wells. This heterostructure is modeled with a system of Schrödinger and kinetic equations self-consistently solved with the Poisson equation. The current components due to these processes contributing to the total dark current are described. The room

temperature performance is finally presented and discussed in terms of responsivity and detectivity.

2. Material parameters

The band offsets between binary α -Sn containing alloys and Ge are not known experimentally [17]. In order to calculate the conduction and valence-band discontinuities between a $\text{Ge}_{1-x}\text{Sn}_x$ strained layer and (001)-oriented relaxed Ge substrate, we have adopted the calculation procedure of Van de Walle *et al* that we outlined in [18] using the parameters taken from [19–21] and the parameters listed in table 1. The following (1)–(4) approximated analytical laws of the conduction and valence-band discontinuities between strain split L and Γ valleys were extracted versus Sn composition:

$$\Delta E_C^\Gamma(x) \cong x(-1.543 + 2.054x) \quad (1)$$

$$\Delta E_C^L(x) \cong x(-0.249 + 0.853x) \quad (2)$$

$$\Delta E_{v,hh}(x) \cong x(1.424 - 0.169x) \quad (3)$$

$$\Delta E_{v,lh}(x) \cong x(1.121 - 0.159x) \quad (4)$$

with energies given in eV. $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ heterointerfaces have type I alignments at Γ - Γ , L - L and Γ - L respective critical points, meaning both electrons, heavy and light holes are confined into $\text{Ge}_x\text{Sn}_{1-x}$ alloys. The relaxed bandgaps of Γ and L valleys in the conduction band (CB) relative to the top of the valence band (VB) are given by:

$$E(\text{Ge}_{1-x}\text{Sn}_x) = (1 - x)E_{\text{Ge}} + xE_{\text{Sn}} - c_b x(1 - x) \quad (5)$$

where c_b is the bowing parameter for direct ($c_b = 2.87$) or indirect ($c_b = 0.89$) band gap energies. The values E_{Ge} and E_{Sn} of the bandgaps at Γ and L valleys for Ge and Sn are given in table 1. The calculated bandgap energies (E_g^Γ and E_g^L , in eV) for strained $\text{Ge}_{1-x}\text{Sn}_x$ layers are given by the analytical expressions below:

$$E_g^{(\Gamma-hh)}(x) = 0.798 - 2.967x + 2.224x^2 \quad (6)$$

$$E_g^{(\Gamma-lh)}(x) = 0.798 - 2.660x + 2.214x^2 \quad (7)$$

$$E_g^{(L-hh)}(x) = 0.659 - 1.673x + 1.022x^2 \quad (8)$$

$$E_g^{(L-lh)}(x) = 0.659 - 1.369x + 1.012x^2. \quad (9)$$

The resulting plots of the energy gaps for compressively strained and relaxed alloys including experimental data values are summarized in figure 1. It is found that pseudomorphic $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ (001) alloys may have a direct bandgap at Sn fractions higher than 10.5% at room temperature. Regarding

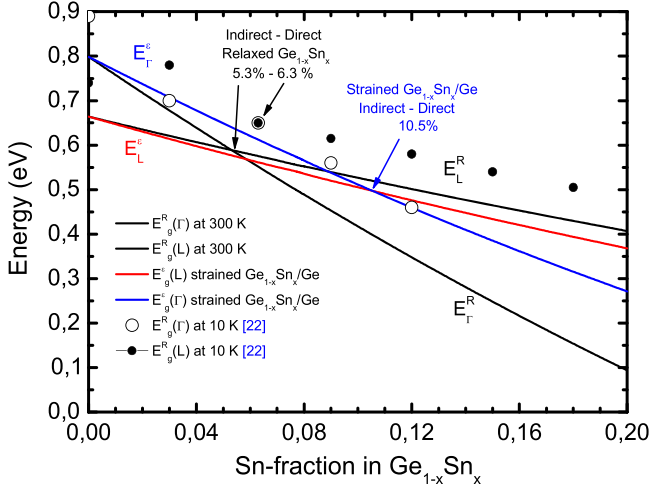


Figure 1. Energy gaps of pseudomorphic and relaxed $\text{Ge}_{1-x}\text{Sn}_x$ alloys. The dashed red and black lines display the indirect pseudomorphic E_L^E and relaxed E_L^R bandgaps, respectively; solid blue and black lines are the direct pseudomorphic E_F^E and relaxed E_F^R bandgaps, respectively. Symbols correspond to available experimental data [22] and E_F^R and E_L^R are obtained by the empirical pseudo-potential method (EPM).

the unstrained $\text{Ge}_{1-x}\text{Sn}_x$ alloys, indirect-to-direct crossing occurs at a Sn fraction of 5.3% at room temperature. The latter values are consistent with the experimental crossovers found in [22] at about 17 and 6.3% respectively for temperatures around 10 K. Additional experimental evidence of the indirect-direct bandgap transition for pseudomorphic $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ (001) would be of fundamental and practical importance.

3. Studied structure and modeling

The structure under investigation consists of 10 periods of intrinsic $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ QW cell. Both compressively strained $\text{Ge}_{0.964}\text{Sn}_{0.036}$ and relaxed Ge barriers are 10 nm thick. The device is sketched in figure 2. The material parameters used are taken from [23–25] and summarized in table 2. The compressive lattice mismatch between $\text{Ge}_{0.964}\text{Sn}_{0.036}$ and Ge is 0.52% while the average mismatch of the 200 nm-thick stacks is 0.26%. Thus the chosen thicknesses are reasonable values regarding the critical thickness of $\text{Ge}_{0.964}\text{Sn}_{0.036}$ layers and strain accumulation within the stack. However, thicker MQWs for better absorption would imply strain compensation through the use of $\text{Si}_{0.13}\text{Ge}_{0.87}$ barriers under tensile strain. The active region is embedded between 70 nm-thick n and p-doped Ge contact layers doped at $N_A = N_D = 1 \times 10^{18} \text{ cm}^{-3}$. For the sake of simplicity, we assume that there are no intrinsic impurities or defects in the host lattice.

The theoretical model and numerical methods used in this paper are based on the self-consistent solving of the one-dimensional Schrödinger equation in the effective mass approximation [26–29] and Poisson equations for electrons and holes. Numerically, the problem was treated using the finite differential method. The electron and hole densities $n(z)$ and $p(z)$ in the contact regions are calculated according to the Boltzmann statistic. Figure 3 shows the conduction- and

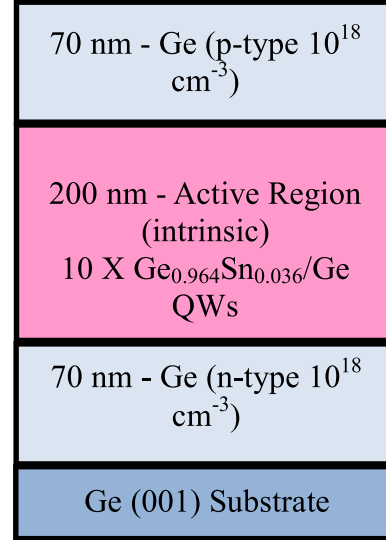


Figure 2. Schematic diagram of a p-i-n photodetector. The cross-sectional view shows the structure of strained GeSn/Ge multiple quantum wells grown on germanium substrate.

valence-band profiles for this ten-period $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ MQW at zero bias. The ground level is drawn for electron, light-hole and heavy-hole with the associated wave function. Electrons fill all available states in the active part of the device according to the Fermi-Dirac $f(E)$ distribution. The Fermi level is linearly varying from $E_{F(p)} = E_F$ at the p contact to $E_{F(n)} = E_F - qV_{\text{bias}}$ at the n contact, where V_{bias} is the applied bias. The formula after Tsu and Esaki generalized for the case of several conduction valleys and anisotropy of effective mass is then used for calculation of the tunneling current. For parabolic dispersion relations with integration over the transverse mass component only, the current density from extended and localized states is written as [30]:

$$J(V) = \frac{qm^*k_B T}{2\pi^2\hbar^3} \times \int_0^\infty \text{tr}(E_z, V_{\text{bias}}) \text{Ln} \left[\frac{1 + \exp(E_f - E_z/k_B T)}{1 + \exp(E_f - E_z - qV_{\text{bias}}/k_B T)} \right] dE_z \quad (10)$$

where the transmission coefficient $\text{tr}(E_z)$ is deduced from the transfer matrix formalism within the step approximation as for the potential [31]; T is the absolute temperature and k_B and \hbar are the Boltzmann and reduced Planck constants, respectively. For an analysis of the thermally activated carrier transport, the current density can be described using the rates $g_{i \rightarrow i+1}$, $g_{i+1 \rightarrow i}$ of electron (or hole) transfer components in two opposite directions, according to [32]:

$$J = \frac{\partial n_i}{\partial t} + \frac{\partial p_i}{\partial t} = (g_{i-1 \rightarrow i}^n n_{i-1} - n_i g_{i \rightarrow i+1}^n - n_i g_{i \rightarrow i-1}^n + n_{i+1} g_{i+1 \rightarrow i}^n) + (-g_{i-1 \rightarrow i}^p p_{i-1} + p_i g_{i \rightarrow i+1}^p + p_i g_{i \rightarrow i-1}^p - p_{i+1} g_{i+1 \rightarrow i}^p) \quad (11)$$

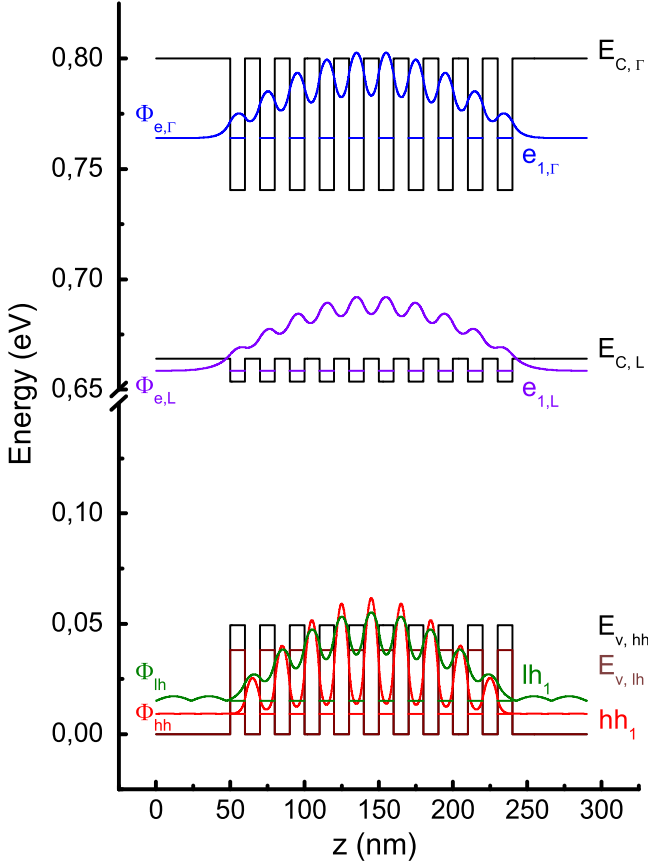


Figure 3. Conduction- and valence-band profiles for ten-period $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ MQWs (the values for band offset and bandgap of $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ are summarized in table 2). The fundamental electron, light-hole and heavy-hole levels are drawn with their relative wave function at Γ and L valleys. Note the envelopes of electron and hole wave functions, meaning $\text{Ge}_{0.964}\text{Sn}_{0.036}$ quantum wells are coupled with a 10 nm thick Ge spacer.

where n_i (p_i) is the electron (hole) concentration in the i th mesh point. This rate, defined within the thermally activated transport theory, includes the image-force effect in the following way [33]:

$$g_{i \rightarrow i+1}^{n,p} = \omega_{0i}^{n,p} \exp\left(\frac{q(\phi_i - \phi_{i+1})}{k_B T}\right) \times \exp\left(-\left(\Delta E_i^{C,V} - \sqrt{\frac{q^3(\phi_i - \phi_{i+1})}{16\pi\epsilon_i\epsilon_0 h z_i}}\right)/k_B T\right) \quad (12)$$

where $h z_i$ is the step of the mesh, ϕ_i is the electrostatic potential in the i th mesh (obtained by solving the Poisson equation), ϵ_i is the dielectric constant in the i th mesh, and ω_0 is the frequency of the local carrier oscillations along the multiple quantum well. The system of kinetic equations has been solved for the stationary case.

In the absence of the optical excitation $G_{ni} = G_{pi} = 0$, it is worth comparing the generalized formula of the dark current density described by equations (10)–(12) with the classical expression given by continuity equations [27] to account

for additional current contributions:

$$J = \frac{\partial n_i}{\partial t} + \frac{\partial p_i}{\partial t} = G_{ni} + G_{pi} - \left(\frac{n_i - n_0}{\tau_{n,i}^{R,NR}} \frac{p_0 + n_i}{p_0} - \frac{p_i - p_0}{\tau_{p,i}^{R,NR}} \frac{n_0 + p_i}{n_0} \right) + J_{\text{Tunnel}}^{\text{Band to Band}} + J_{\text{Tunnel}}^{\text{Electrons}} + J_{\text{Tunnel}}^{\text{Holes}} + \left(n_i \mu_{ni} \frac{\partial \xi_i}{\partial z_i} + \mu_{ni} \xi_i \frac{\partial n_i}{\partial z_i} - p_i \mu_{pi} \frac{\partial \xi_i}{\partial z_i} - \mu_{pi} \xi_i \frac{\partial p_i}{\partial z_i} \right) + \left(D_i^n \frac{\partial^2 n_i}{\partial z_i^2} + D_i^p \frac{\partial^2 p_i}{\partial z_i^2} \right) \quad (13)$$

where n_0 and p_0 are the electron and hole free carrier concentrations at thermodynamic equilibrium, G_{ni} and G_{pi} are the electron and hole optical generation rates, $\mu_i^{n,p}$ is the electron (or hole) mobility, $D_i^{n,p}(T) = \frac{k_B T}{q} \mu_i^{n,p}(T) = \frac{k_B T}{q} \left(\frac{q \tau_i^{n,p}}{m_{e,h}^\perp} \right)$ is the electron (or hole) diffusion coefficient, $\tau_i^{n,p}$ is the averaged scattering times for electrons or holes, $\xi_i = \partial \phi_i / \partial z_i$ is the applied electric field, and $\tau_{n,p,i}^{R,NR}$ is the average time for the radiative and non radiative recombination process for electrons (or holes) in the i th point mesh, e.g. $\frac{1}{\tau_{n,p,i}^{R,NR}} = \frac{1}{\tau_{n,p,i}^R} + \frac{1}{\tau_{n,p,i}^{NR}}$. In the present work, we do not consider the contributions on the generation-recombination current of the Shockley–Read–Hall recombination of carriers on traps, e.g. $\tau_{n,p,i}^{NR} \rightarrow \infty$ for first term of equation (13), neither the three carrier Auger mechanisms, nor the band-to-band tunneling mechanism that are valid assumptions for low concentrations of photo-carriers and low reverse voltages of a p-i-n photodiode. The two sets of equations (10)–(12) or (13) thus account for same current contributions.

In the particular case of a GeSn absorbing layer (not MQWs), e.g. $\Delta E_i^{C,V} = 0$ and no image-force effect, if one considers a first-order finite development on the electrostatic potential difference within a mesh, the transfer rate given in equation (12) reduces to: $g_{i \rightarrow i+1}^{n,p} \cong \omega_{0i}^{n,p} \left(1 + \frac{q(\phi_i - \phi_{i+1})}{k_B T} \right)$. Using the same linear development for all derivative terms of the conduction and diffusion currents given in second part of equation (13), by comparing with those extracted from equation (13), one can find [34]:

$$\omega_{0i}^{n,p} \cong \frac{D_i^{n,p}(T)}{(h z_i)^2} = \frac{k_B T}{q} \frac{\mu_i^{n,p}(T)}{(h z_i)^2} = \frac{k_B T}{q} \left(\frac{q \tau_i^{n,p}}{m_{e,h}^\perp} \right) \frac{1}{(h z_i)^2}. \quad (14)$$

In the absence of tunnel barriers, this remarkable formula links the frequency of local carrier oscillations along the structure and their averaged times $\tau_i^{n,p}$ of scattering with impurities, lattice phonons and alloy disorder. It is valid only if the step of the mesh $h z_i$ is of the order of magnitude

Table 2. Parameters at 300 K used for the simulation of the p-i-n $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ MQW based photodetectors.

Parameters	Values
Electron effective mass $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ $m_{F,e}^*$	0.032 m_0 [23]
Electron effective mass $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ $m_{L,e}^*$	0.078 m_0 [23]
Heavy hole effective mass $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ m_{hh}^*	0.199 m_0 [23]
Light hole effective mass $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ m_{lh}^*	0.061 m_0 [23]
Bandgap $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ E_g^{I-hh}	0.694 eV (present work)
Bandgap $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ E_g^{I-lh}	0.705 eV (present work)
Bandgap $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ E_g^{L-hh}	0.600 eV (present work)
Bandgap $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ E_g^{L-lh}	0.611 eV (present work)
Conduction band-offset $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ ΔE_C^C	-0.053 eV (present work)
Conduction band-offset $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ ΔE_C^L	-0.008 eV (present work)
Valence band-offset $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ ΔE_{hh}^V	0.051 eV (present work)
Valence band-offset $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ ΔE_{lh}^V	0.040 eV (present work)
Electron carrier recombination lifetime τ_{ni}	9 μs [24]
Electron carrier recombination lifetime τ_{pi}	9 μs [24]
Electron carrier mobility $\mu_{ni}(T)$	$\approx (m_{i,e}^*)^{-1/2} T^{3/2}$ [25]
Hole carrier mobility $\mu_{pi}(T)$	$\approx (m_{i,h}^*)^{-1/2} T^{3/2}$ [25]
Acceptor concentration, N_A	10^{18} cm^{-3}
Donor concentration, N_D	10^{18} cm^{-3}

of the QW width. For a 10 nm thick Ge QW, taking a room temperature mobility of $3900 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ and $1900 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ for electrons and holes, one can find $\omega_0^{n,p} \cong (10-15 \text{ fs})^{-1}$, respectively.

4. Results and discussion

Figure 4 compares the dark current–voltage (I – V) characteristics calculated at room temperature for bulk $\text{Ge}_{0.964}\text{Sn}_{0.036}$ and $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ MQW active regions. A good agreement of the calculated and experimental dark currents [15] is obtained for a $200 \mu\text{m}$ thick bulk $\text{Ge}_{0.964}\text{Sn}_{0.036}$ active region, a mesa diode diameter of $150 \mu\text{m}$, and a $9 \mu\text{s}$ [24] generation–recombination time of carriers. Such an experimental device has a typical dark-current of $1.2 \cdot 10^{-6} \text{ A}$ at -1 V . The use of MQWs as the active region increases the serial resistance [22] and thus decreases the dark current around $3.1 \cdot 10^{-7} \text{ A}$ for the same -1 V reverse voltage.

In order to understand the evolution of the dark current with the bias voltage, it is necessary to determine the respective influence of each component originating from the different considered mechanisms that include the conduction, diffusion, recombination and thermally activated tunnel currents. The calculation of each current component has been carried out at room temperature using the approach described in the previous section. Results are illustrated in figure 5. It is shown that the thermal diffusion and the well describe the forward bias characteristic while the behavior of the total dark current under reverse polarization thoroughly agree with the sum of the tunneling and recombination current contributions. The diffusion component remains the main mechanism for low ($<0.5 \text{ V}$) direct bias voltages.

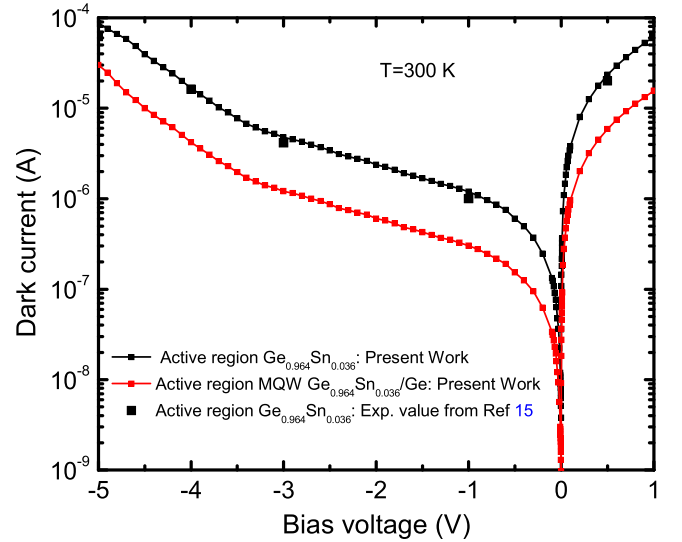


Figure 4. Dark current–voltage characteristics of a GeSn p-i-n photodetector with a Sn content of 3.6% for devices with different active region $\text{Ge}_{0.964}\text{Sn}_{0.036}$ and MQW $\text{Ge}/\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$. The symbols are the experimental data taken from [15].

Next we have investigated the influence of α -Sn concentration on the I – V dark characteristics. The results of our simulations of the dark current–voltage characteristics at room temperature for a pure bulk Ge p-i-n photodiode and two devices based on ten-period strained $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ MQWs with different α -Sn compositions, are illustrated in figure 6.

The dark current density not only indicates the material quality but also determines the optical receiver sensitivity. A direct comparison with the experimental results pointed out by recent investigations [15] proves that our proposed

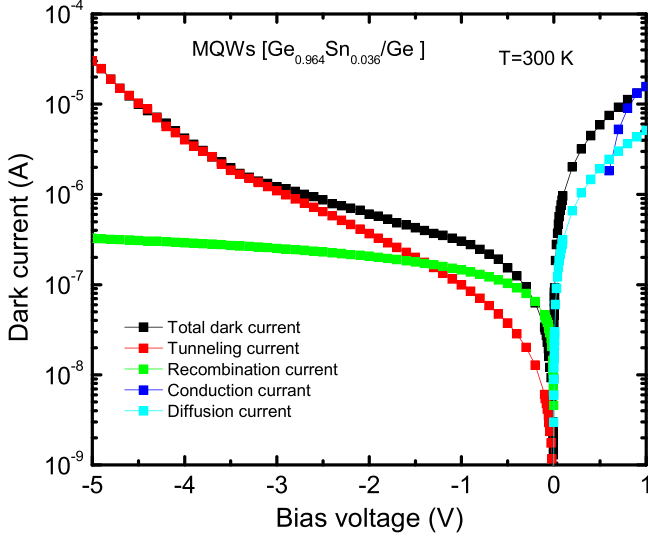


Figure 5. Total dark current at 300 K as a function of bias voltage from -5 V to 1 V is shown with four distinct regimes and different dominant mechanisms, the conduction current density, diffusion current density, recombination current density and tunneling current density.

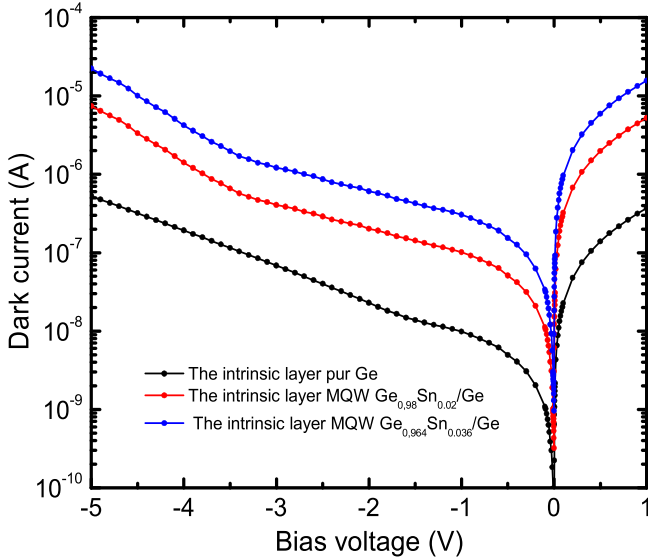


Figure 6. I - V characteristics of the devices with different Sn concentrations (device radius $150 \mu\text{m}$).

structure allows improvement of the performance of the photodiode. The optical responsivity is obtained using the following expression:

$$R(\lambda) = \frac{\eta_i q \lambda \Omega}{hc} \frac{\Gamma \alpha(\lambda, V)}{\Gamma \alpha(\lambda, V) + \alpha_i} \times (1 - \exp(-(\alpha_i + \Gamma \alpha(\lambda, V))L)) \quad (15)$$

where η_i is the internal quantum efficiency, Γ is the confinement factor of the optical mode within the multiple quantum wells, $\alpha(\lambda, V)$ is the absorption coefficient at wavelength λ and bias V , L is the waveguide length, and Ω

is the coupling efficiency, including mode size mismatch and reflection [35]. α_i accounts for all the propagation losses that do not generate photocurrent. We used $\eta_i = 1$, $\Gamma = 0.38$, $\Omega = 0.25$, $\alpha_i = 120 \text{ cm}^{-1}$ and $\alpha(\lambda, V)$ was theoretically calculated according to the formula outlined in our previous work [23].

The room temperature responsivity for three reverse bias voltages (0 V, -1 V and -3 V) are given in figure 7(a). This responsivity versus wavelength (0.9 – $2.3 \mu\text{m}$) shows two peaks. These peaks corresponding to the hh_1 – $c\Gamma_1$ transition energy and the strained direct bandgap of $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ QWs are observed around 1550 nm and 1781 nm , respectively. Similarly, we can see that the responsivity decreases when the reverse bias voltage increases. Under a reverse bias voltage of -3 V, the responsivities of 0.62 A W^{-1} at 1550 nm and 0.71 A W^{-1} at 1781 nm are obtained at room temperature.

Afterwards, we investigated the effect of the concentration of α -Sn on the optical responsivity for the $\text{Ge}/\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ p-i-n photodetector at zero bias. Figure 7(b) shows that an increase of the optical responsivity for higher wavelengths can be observed with increasing α -Sn content at 0 V. We found that the $\text{Ge}_{0.98}\text{Sn}_{0.02}/\text{Ge}$ MQW photodetector is achieved with a responsivity of 240 mA W^{-1} at the telecommunication wavelength of $1.55 \mu\text{m}$. The response of the photodetector with Sn 2% is significantly higher than that reported in [36]. In addition, a rise of 3.6% of the α -Sn amount leads to an increase greater than an order of magnitude on the responsivity. Indeed, the optical responsivity curve of the $\text{Ge}_{0.964}\text{Sn}_{0.036}/\text{Ge}$ p-i-n MQW is shifted $\sim 500 \text{ nm}$ to higher wavelengths compared with pure Ge. At $\lambda = 1.781 \mu\text{m}$, an optical responsivity of $\sim 306 \text{ mA W}^{-1}$ is observed for the $\text{Ge}_{1-x}\text{Sn}_x/\text{Ge}$ p-i-n photodetector with 3.6% α -Sn, whereas the Ge reference photodetector without α -Sn shows an optical responsivity of 0.17 A W^{-1} . Compared to Ge photodetector, responsivity is improved in the whole wavelength range from $0.9 \mu\text{m}$ to $2.3 \mu\text{m}$. Gassenq *et al* [37] found that an increase of Sn content enhances the responsivity of the detector in the telecom wavelength range and extends the cut-off wavelength beyond $2.4 \mu\text{m}$.

Besides the dark current, we can test the MQW's performance by its detectivity D^* which depends on the wavelength of incident light λ . The detectivity is given by the B L Sharma simplified formula:

$$D^*(\lambda) = \frac{1}{2} R(\lambda) (qJ_0)^{-\frac{1}{2}} \quad (16)$$

where λ is the operating wavelength and J_0 is the dark current density.

Using this expression in the region of zero bias voltage of the p–n junction, we have calculated room-temperature specific detectivity at a 1550 nm wavelength peak of responsivity. $D^* 7.9 \cdot 10^{10} \text{ cm Hz}^{1/2} \text{ W}^{-1}$ and $\sim 3.8 \cdot 10^{10} \text{ cm Hz}^{1/2} \text{ W}^{-1}$ have been achieved under reverse bias voltage of -0.5 V and -1 V, respectively, at 300 K . We have not investigated the temperature effect. Conley *et al* [38] found that the detectivity of GeSn photoconductors as expected increases with Sn increasing content when temperature decreases. But their device exhibits a poor value of detectivity of about $1 \cdot 10^9 \text{ cm}$

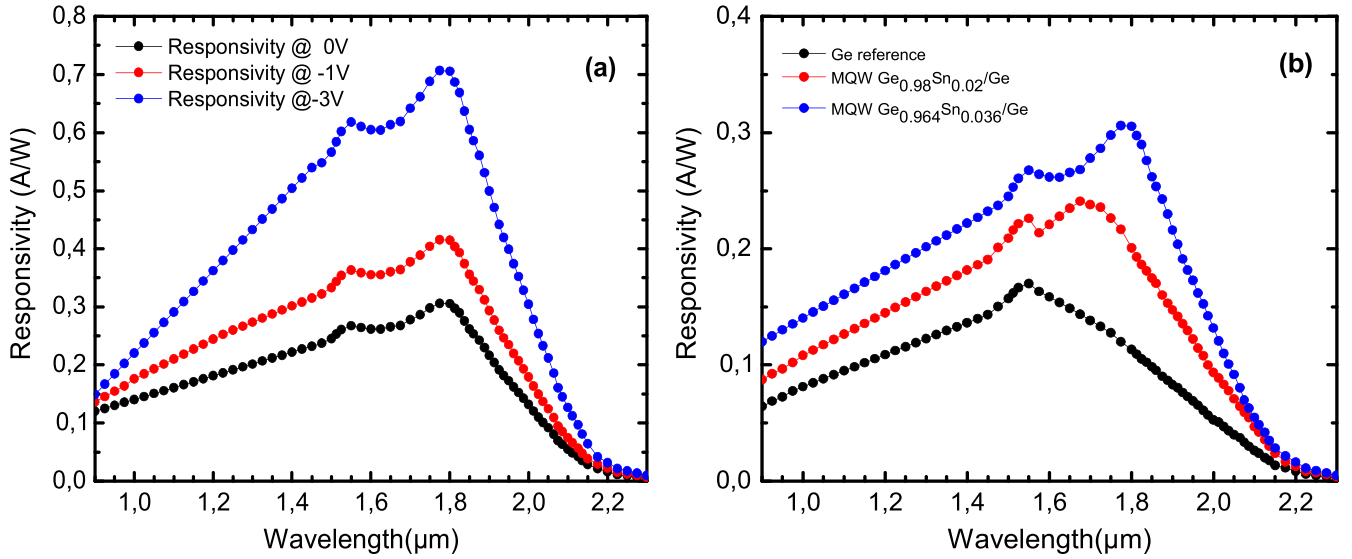


Figure 7. (a) Optical responsivity from $\lambda=900$ nm up to $\lambda=2300$ nm for the Ge_{0.964}Sn_{0.036}/Ge p-i-n photodetectors at 0, -1 and -3 V, respectively. (b) Responsivity versus wavelength with different Sn concentrations at reverse zero bias.

$\text{Hz}^{1/2} \text{W}^{-1}$ at $1.55 \mu\text{m}$, as compared to the results of Zhang *et al* [15].

GeSn/Ge p-i-n photodetectors operating in the infrared region ($1.3\text{--}1.55 \mu\text{m}$) are finding extensive applications in long haul and high bit rate optical communication systems and local area networks [39–41].

In addition to optical communication, these devices are also useful for sensing applications as they have superior electro-optical characteristics, namely low dark current, high quantum efficiency, greater sensitivity and high speed of response.

5. Conclusion

In summary, we have theoretically studied the group-IV semiconductor in which the GeSn relaxed alloys have a direct bandgap for 5.3% α -Sn. Our investigation predicts, at room temperature, a direct bandgap for strained Ge_{1-x}Sn_x/Ge (001) structures at a α -Sn fraction higher than 10.5%. We have theoretically simulated the characteristics of GeSn/Ge p-i-n photodetector with Sn contents up to 3.6%. The electrical and optical properties are compared with a similar Ge p-i-n reference photodetector without Sn. An increase of Sn content shifts the optical responsivity curve to higher wavelengths compared with pure Ge. The simulation of the responsivity ($0.9\text{--}2.3 \mu\text{m}$) shows that the detectors have a photo-response up to $2.1 \mu\text{m}$, covering the entire telecommunication range. In particular, considering the absorption of the strained direct bandgap of the Ge_{0.964}Sn_{0.036}/Ge quantum wells, good responsivities of 0.62 A W^{-1} at 1550 nm and 0.71 A W^{-1} at 1781 nm were obtained at a reverse bias voltage of -3 V . Consequently, Ge_{1-x}Sn_x/Ge heterostructures are a promising candidate material not only for all telecommunication bands in optoelectronics but also for near infrared applications.

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